Analog Power AM20N20-125D MOSFET Datasheet

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Key Features:
Low rDS(on) trench technology
Low thermal impedance
Fast switching speed
Typical Applications:
White LED boost converters
Automotive Systems
Industrial DC/DC Conversion Circuits

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N-Channel 200-V (D-S) MOSFET

Key Features:

- Low r_{DS(on)} trench technology
- · Low thermal impedance
- · Fast switching speed

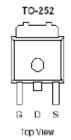
Typical Applications:

- White LED boost converters
- Automotive Systems
- Industrial DC/DC Conversion Circuits

PRODUCT SUMMARY			
V _{DS} (V)	$r_{DS(on)}(m\Omega)$	I _D (A)	
200	260 @ V _{GS} = 10V	12	
200	$300 @ V_{GS} = 5.5V$	11	







ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}$ C UNLESS OTHERWISE NOTED)						
Parameter		Symbol	Limit	Units		
Drain-Source Voltage	V_{DS}	200	V			
Gate-Source Voltage	V_{GS}	±20	V			
Continuous Drain Current a	T _C =25°C	I _D	12	Α		
Pulsed Drain Current ^b	I _{DM}	50	^			
Continuous Source Current (Diode Conduction)	I _S	47	Α			
Power Dissipation ^a	T _C =25°C	P_{D}	50	W		
Operating Junction and Storage Temperature Range			-55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Maximum	Units		
Maximum Junction-to-Ambient ^a	t <= 10 sec	D	40	°C/W		
IMAXIIIUIII JUIICIIOII-IO-AIIIDIEIII	Steady State	$R_{\theta JA}$	3	C/VV		

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

Electrical Characteristics

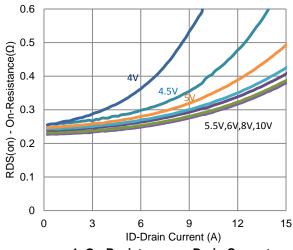
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Static						
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \text{ uA}$				V
Gate-Body Leakage	I _{GSS}				±100	nA
Zara Cata Valtaga Drain Correct	1	$V_{DS} = 160 \text{ V}, V_{GS} = 0 \text{ V}$			1	uA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 160 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			25	
On-State Drain Current	I _{D(on)}	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	24			Α
Drain-Source On-Resistance	r	$V_{GS} = 10 \text{ V}, I_D = 9.6 \text{ A}$			260	mΩ
Dialii-Source Oil-Resistance	r _{DS(on)}	$V_{GS} = 5.5 \text{ V}, I_D = 8.3 \text{ A}$			300	11122
Forward Transconductance	g _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 9.6 \text{ A}$		4.4		S
Diode Forward Voltage	V_{SD}	$I_{S} = 23 \text{ A}, V_{GS} = 0 \text{ V}$		0.95		V
Dynamic						
Total Gate Charge	Q_g			4		nC
Gate-Source Charge	Q_{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 9.6 \text{ A}$		1.7		
Gate-Drain Charge	Q_{gd}			1.8		
Turn-On Delay Time	t _{d(on)}			10		
Rise Time	t _r	$V_{DS} = 100 \text{ V}, R_{L} = 10.5 \Omega, I_{D} = 9.6 \text{ A},$ $V_{GEN} = 10 \text{ V}, R_{GEN} = 6 \Omega$		8		ne
Turn-Off Delay Time	$t_{d(off)}$			27		ns
Fall Time	t _f			13		
Input Capacitance	C _{iss}			807		
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		81		pF
Reverse Transfer Capacitance	ance C _{rss}			38		

Notes

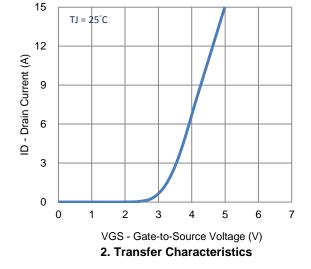
- a. Pulse test: PW <= 300us duty cycle <= 2%.
- b. Guaranteed by design, not subject to production testing.

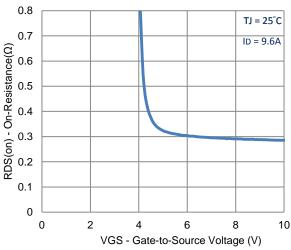
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Typical Electrical Characteristics

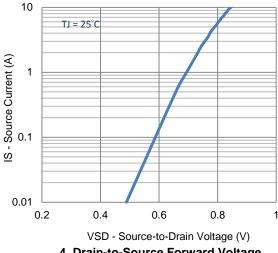


1. On-Resistance vs. Drain Current

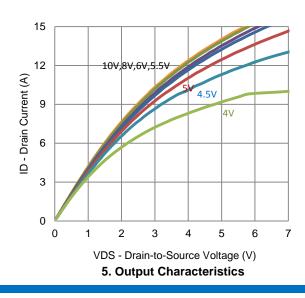


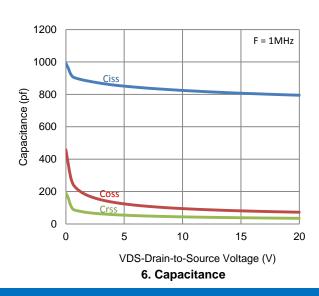


3. On-Resistance vs. Gate-to-Source Voltage



4. Drain-to-Source Forward Voltage



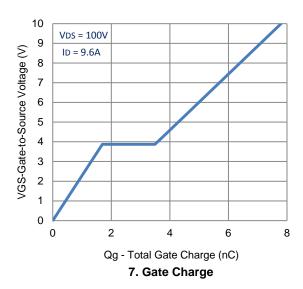


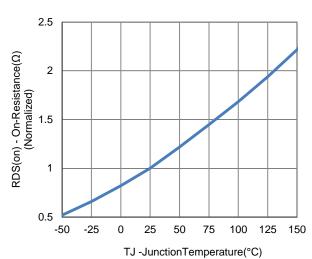
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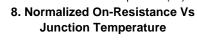
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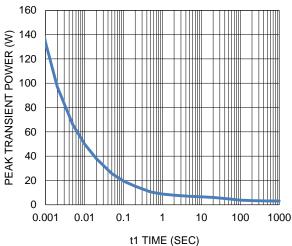
3

Typical Electrical Characteristics



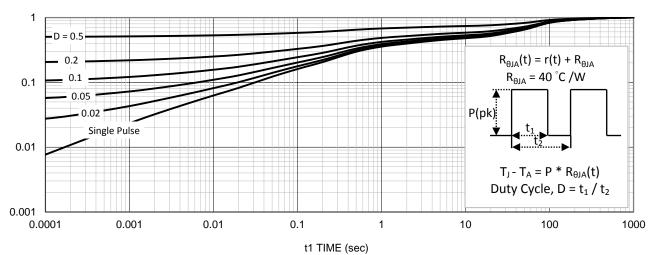






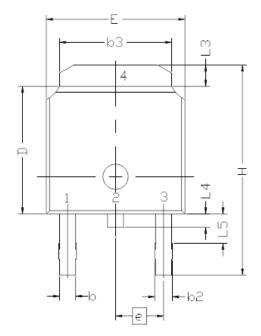
9. Safe Operating Area

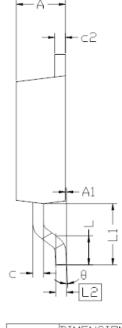
10. Single Pulse Maximum Power Dissipation

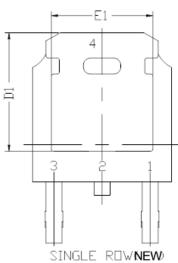


11. Normalized Thermal Transient Junction to Ambient

Package Information







CVMDDI	DIMENS:	[DNAL	REQMTS
SYMBOL	MIN	NDM	MAX
E	6.40	6.60	6.731
L	1.40	1.52	1.77
L1		.743 R	
L2	0.	508 BS	
L3	0,89		1.27
L4	0.64		1.01
L5			
D	6.00	6.10	6,223
Н	9.40	10.00	10.40
b	0.64	0.76	0.88
b2	0.77	0.84	1.14
b3	5,21	5.34	5.46
е	2.	286 BS)C
Α	2,20	2.30	2,38
A1	0		0.127
C	0.45	0.50	0.60
c2	0.45	0,50	0.58
D1	5.30		
E1	4.40		
θ	0°		10°

Note:

- 1. All Dimension Are In mm.
- 2. Package Body Sizes Exclude Mold Flash, Protrusion Or Gate Burrs. Mold Flash, Protrusion Or Gate Burrs Shall Not Exceed 0.10 mm Per Side.
- 3. Package Body Sizes Determined At The Outermost Extremes Of The Plastic Body Exclusive Of Mold Flash, Gate Burrs And Interlead Flash, But Including Any Mismatch Between The Top And Bottom Of The Plastic Body.